

General Description:

The LWS1H90B4 uses advanced SGT technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications. The package form is TO-252, which accords with the ROHS standard and Halogen Free standard.

Features:

- Fast Switching
- Low Gate Charge and $R_{DS(ON)}$
- Low Reverse transfer capacitances

Applications:

- DC-DC Converter
- Portable Equipment
- Power Management

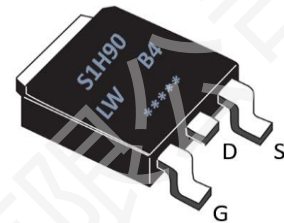
100% DVDS Tested

100% Avalanche Tested

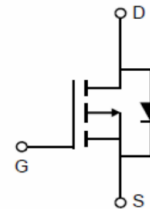


V_{DSS}	-100	V
I_D	-25	A
P_D	80	W
$R_{DS(ON)}$ TYPE	73	mΩ

Marking and Pin Assignment



Inner Equivalent Principium Chart



Package Marking and Ordering Information:

Marking	Part Number	Package	Packing	Qty.
S1H90/LW B4/D.C.	LWS1H90B4	TO-252	Reel	2500 Pcs

Absolute Maximum Ratings:

Symbol	Parameter		Value	Units
V_{DSS}	Drain-to-Source Voltage		-100	V
I_D	Continuous Drain Current	$T_C=25^{\circ}\text{C}$	-25	A
	Continuous Drain Current	$T_C=100^{\circ}\text{C}$	-16	A
I_{DM}^{a1}	Pulsed Drain Current		-100	A
E_{AS}^{a2}	Single pulse avalanche energy		42	mJ
V_{GS}	Gate-to-Source Voltage		± 20	V
P_D	Power Dissipation		80	W
T_J, T_{STG}	Operating Junction and Storage Temperature Range		150, -55 to 150	$^{\circ}\text{C}$
T_L	Maximum Temperature for Soldering		260	$^{\circ}\text{C}$

Thermal Characteristics:

Symbol	Parameter	Value	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	1.56	$^{\circ}\text{C}/\text{W}$
$R_{\theta JA}^{a3}$	Thermal Resistance, Junction-to-Ambient	91	$^{\circ}\text{C}/\text{W}$

Electrical Characteristic ($T_J = 25\text{ }^{\circ}\text{C}$, unless otherwise specified):

Static Characteristics						
Symbol	Parameter	Test Conditions	Value			Units
			Min.	Typ.	Max.	
V_{DSS}	Drain to Source Breakdown Voltage	$V_{GS}=0V, I_D=-250\mu A$	-100	--	--	V
I_{DSS}	Drain to Source Leakage Current	$V_{DS}=-100V, V_{GS}=0V$	--	--	-1.0	μA
$I_{GSS(F)}$	Gate to Source Forward Leakage	$V_{GS}=-20V, V_{DS}=0V$	--	--	-100	nA
$I_{GSS(R)}$	Gate to Source Reverse Leakage	$V_{GS}=+20V, V_{DS}=0V$	--	--	100	nA
$V_{GS(TH)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=-250\mu A$	-1.3	-1.8	-2.5	V
$R_{DS(ON)1}$	Drain-to-Source On-Resistance	$V_{GS}=-10V, I_D=-10A$	--	73	89	m Ω
$R_{DS(ON)2}$	Drain-to-Source On-Resistance	$V_{GS}=-4.5V, I_D=-8.0A$	--	90	110	m Ω

Dynamic Characteristics						
Symbol	Parameter	Test Conditions	Value			Units
			Min.	Typ.	Max.	
C_{iss}	Input Capacitance	$V_{GS}=0V$	--	1077	--	pF
C_{oss}	Output Capacitance	$V_{DS}=-50V$	--	82.5	--	
C_{rss}	Reverse Transfer Capacitance	$f=1.0MHz$	--	9.59	--	
R_G	Gate resistance	$V_{GS}=0V, V_{DS}=0V, f=1MHz$	--	21	--	Ω

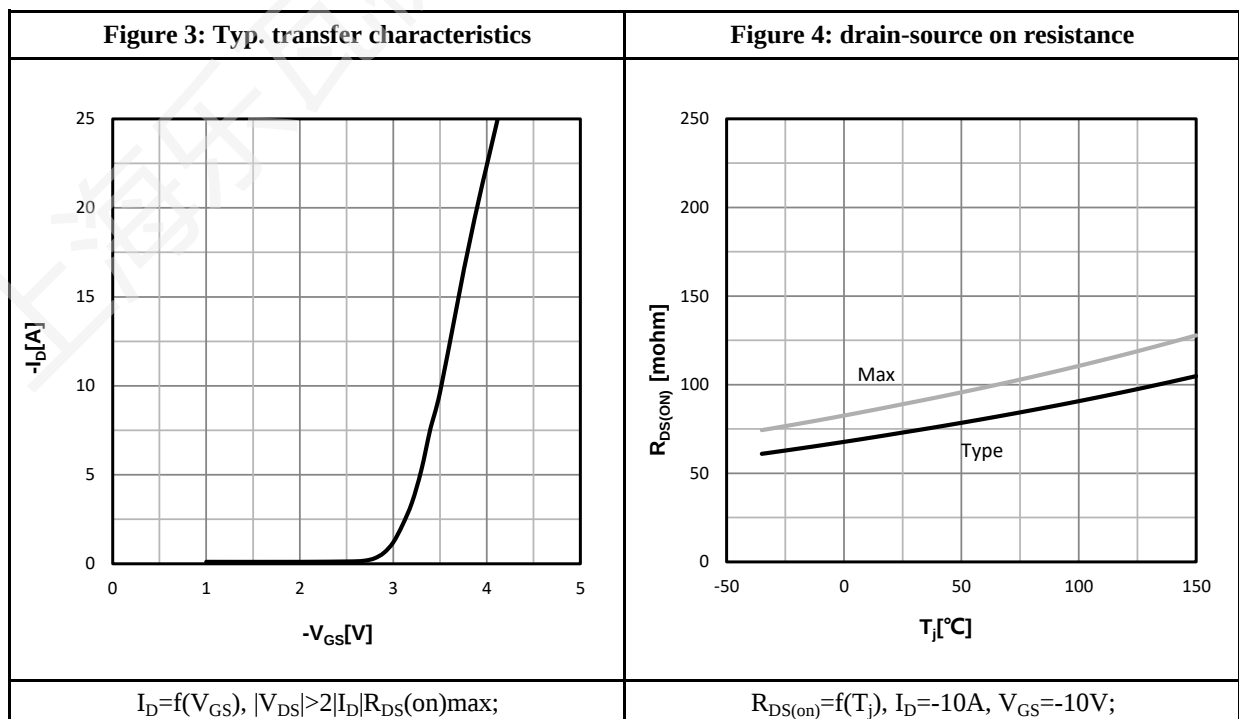
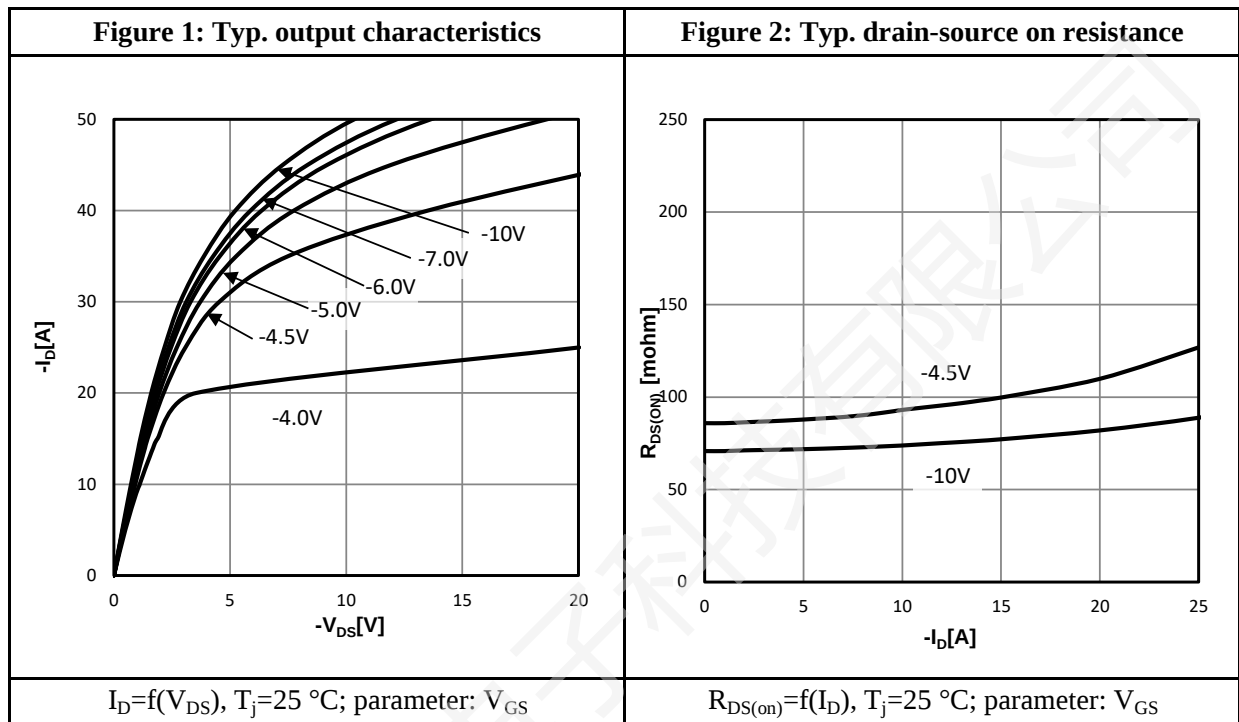
Resistive Switching Characteristics						
Symbol	Parameter	Test Conditions	Value			Units
			Min.	Typ.	Max.	
$t_{d(ON)}$	Turn-on Delay Time	$I_D=-10A$	--	8.8	--	ns
t_r	Rise Time	$V_{DS}=-50V$	--	16	--	
$t_{d(OFF)}$	Turn-Off Delay Time	$V_{GS}=-10V$	--	60	--	
t_f	Fall Time	$R_G=5.0\Omega$	--	41	--	
Q_g	Total Gate Charge	$V_{GS}=-10V$	--	20	--	nC
Q_{gs}	Gate to Source Charge	$V_{DS}=-50V$	--	4.3	--	
Q_{gd}	Gate to Drain Charge	$I_D=-10A$	--	3.5	--	

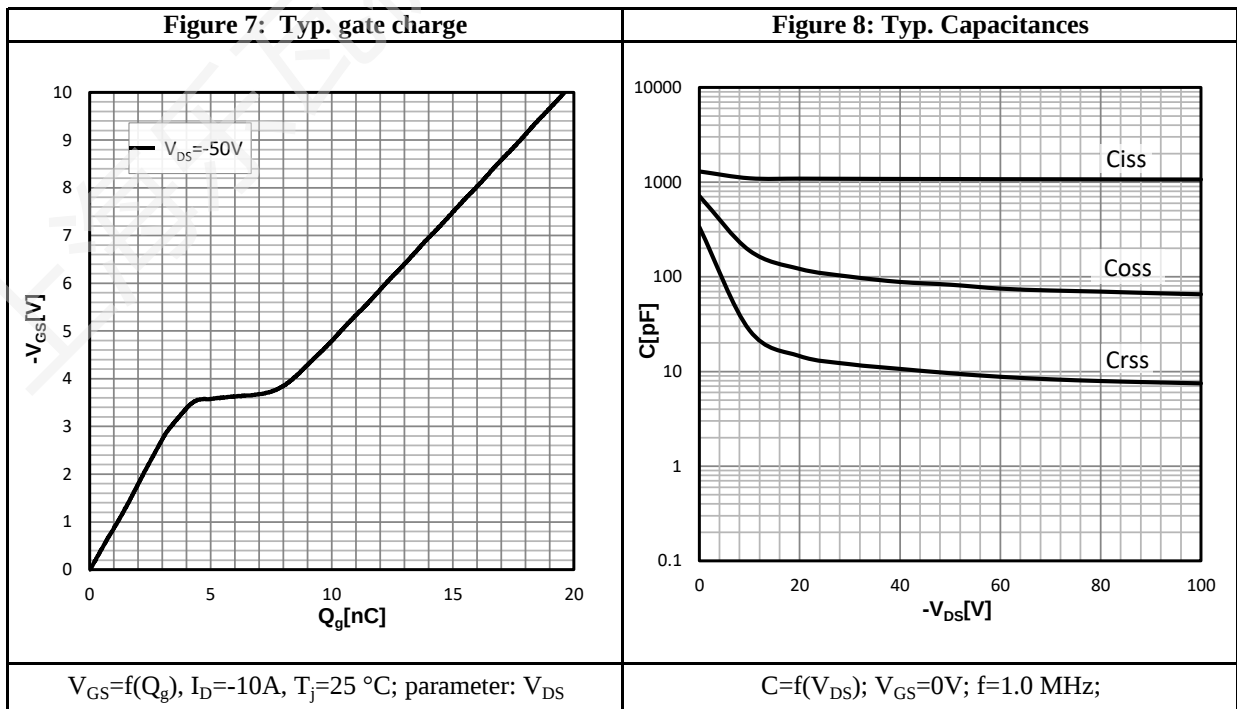
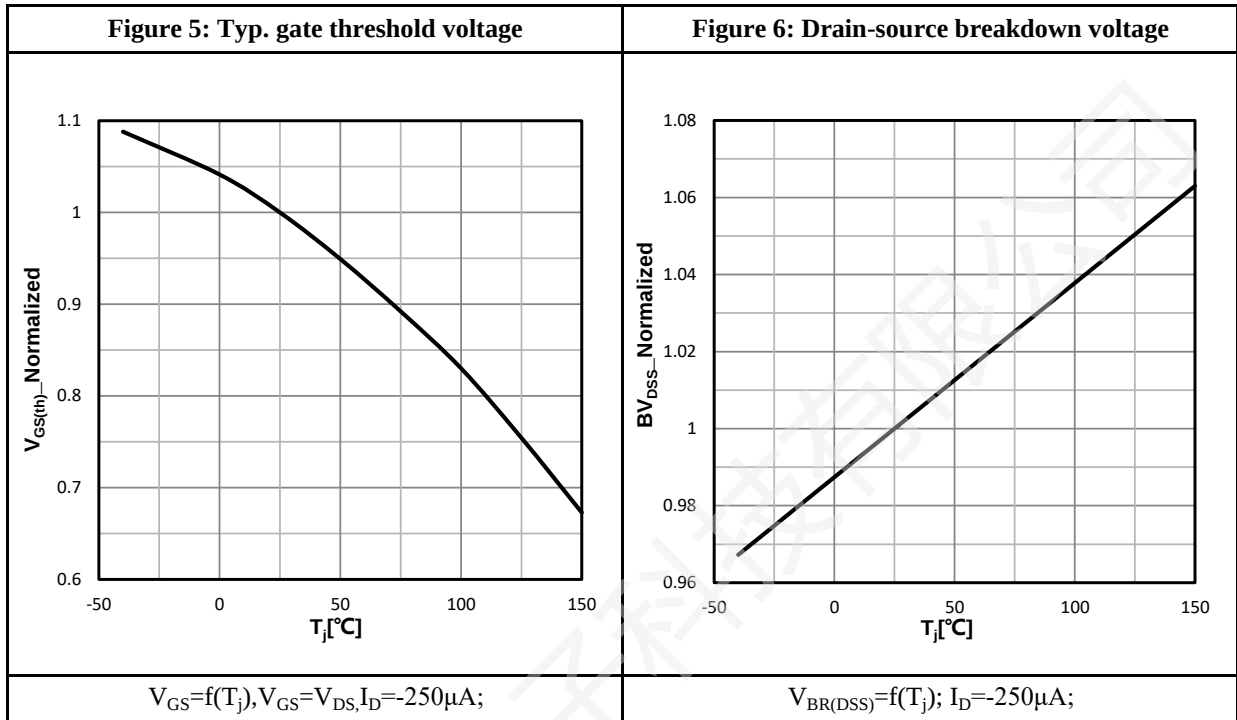
Source-Drain Diode Characteristics						
Symbol	Parameter	Test Conditions	Value			Units
			Min.	Typ.	Max.	
I_S	Diode Forward Current	$T_C=25\text{ }^{\circ}\text{C}$	--	--	-25	A
V_{SD}	Diode Forward Voltage	$I_S=-10A, V_{GS}=0V$	--	--	-1.2	V
t_{rr}	Reverse Recovery Time	$I_S=-10A, V_{DD}=-50V$	--	47	--	ns
Q_{rr}	Reverse Recovery Charge	$dI/dt=100A/\mu s$	--	132	--	nC

a1: Repetitive rating; pulse width limited by maximum junction temperature

a2: $V_{DD}=-50V, L=0.1mH, R_G=25\Omega$, Starting $T_J=25\text{ }^{\circ}\text{C}$

a3: Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 μm thick) copper area for drain connection.

Characteristics Curve:




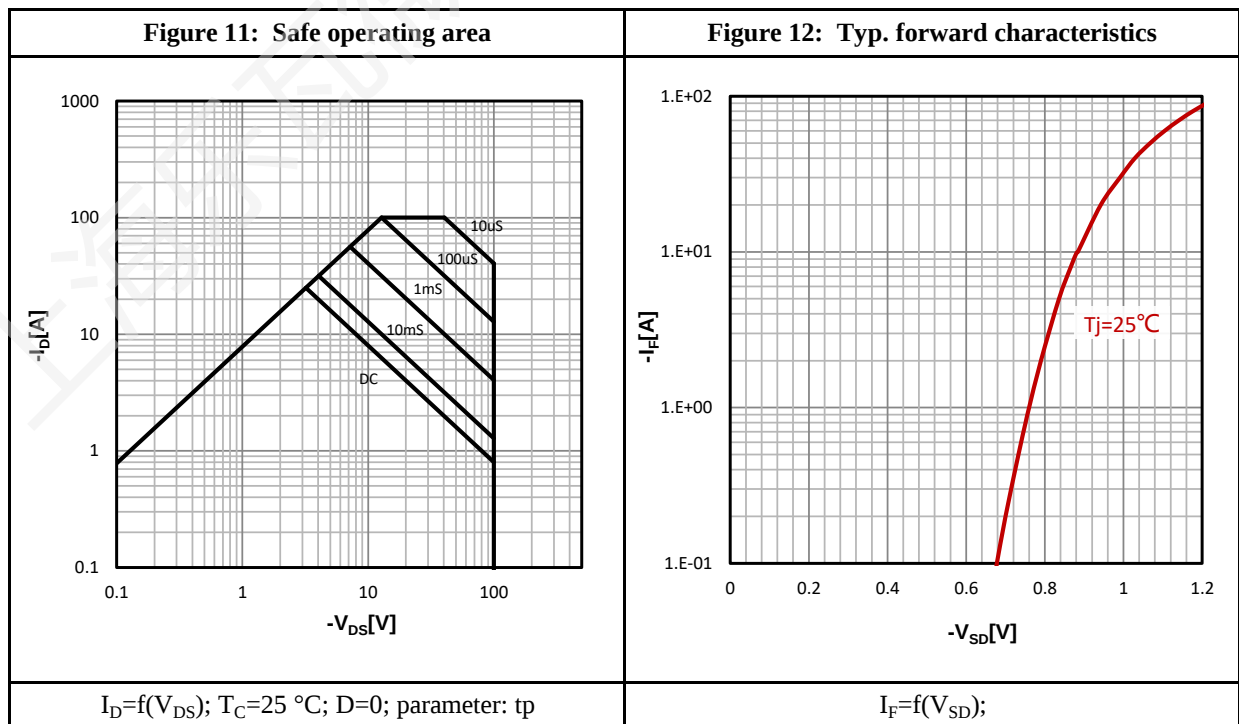
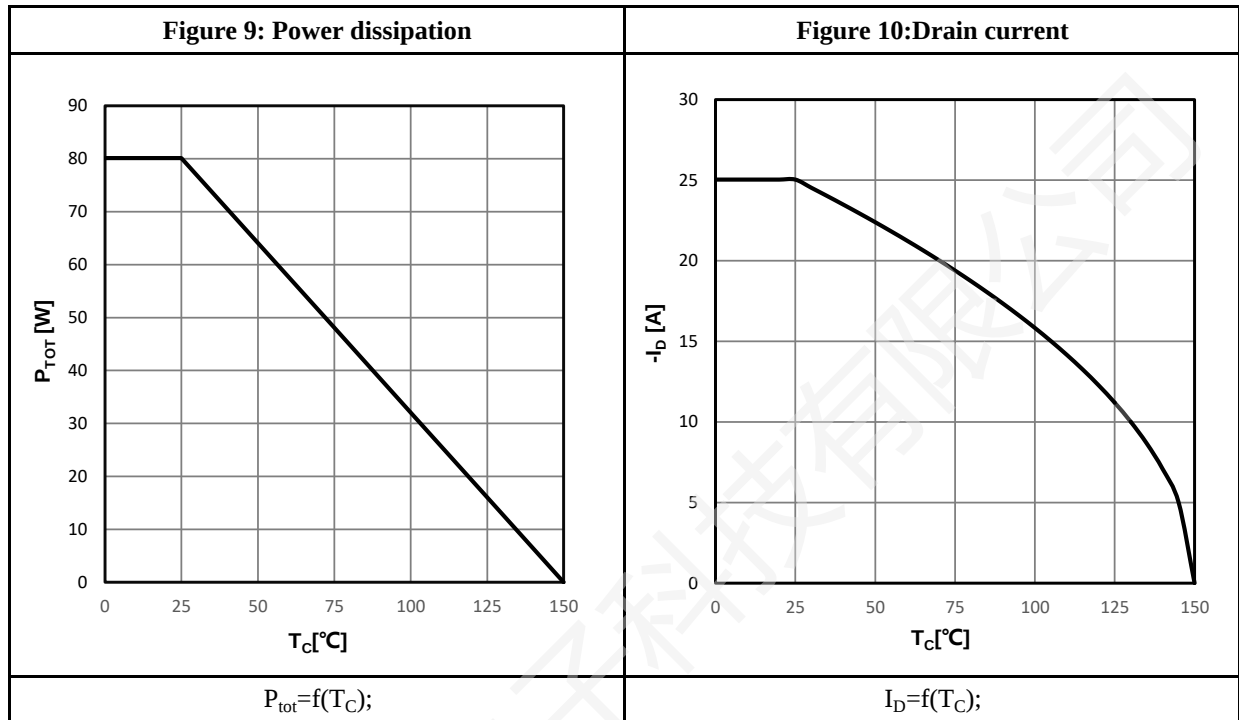
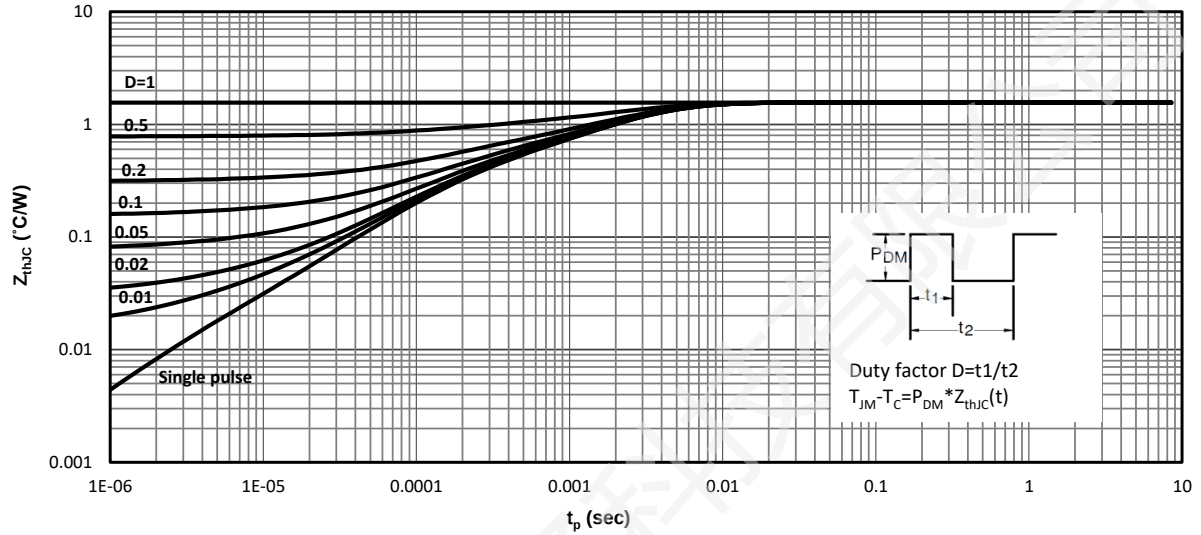
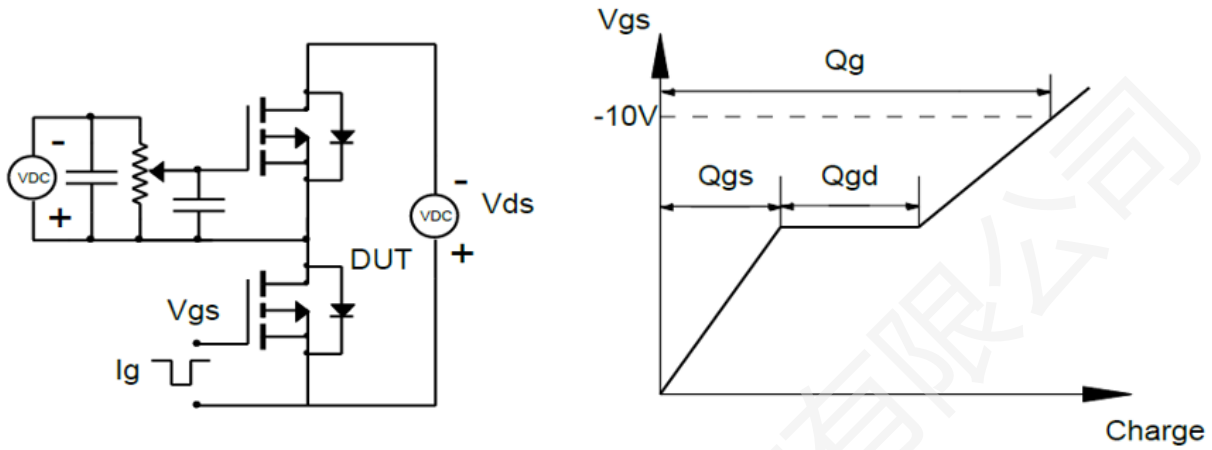
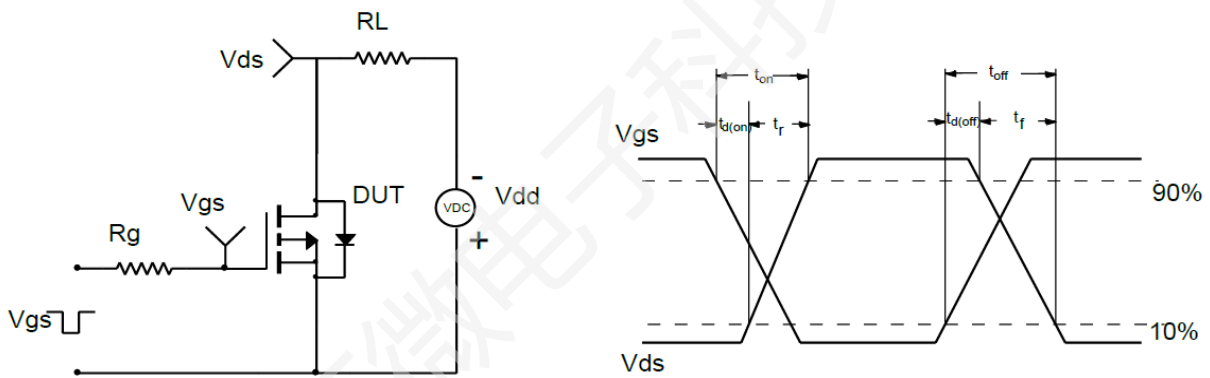
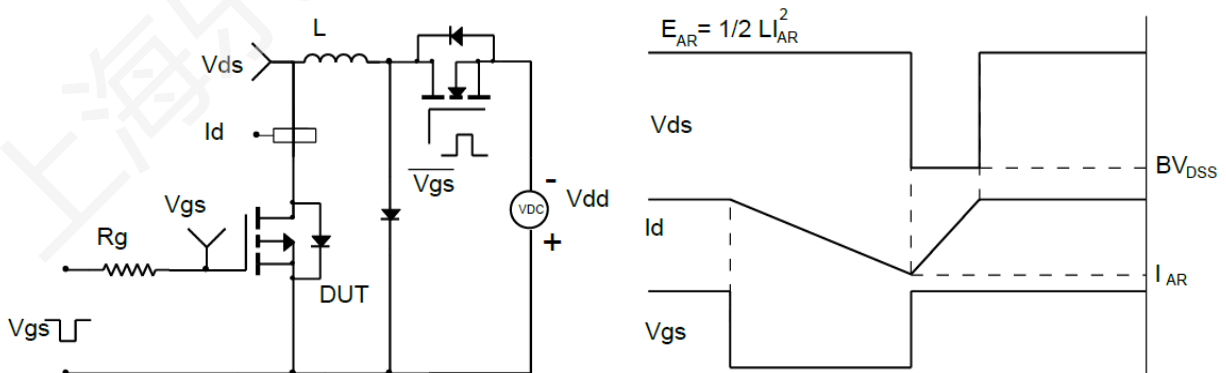
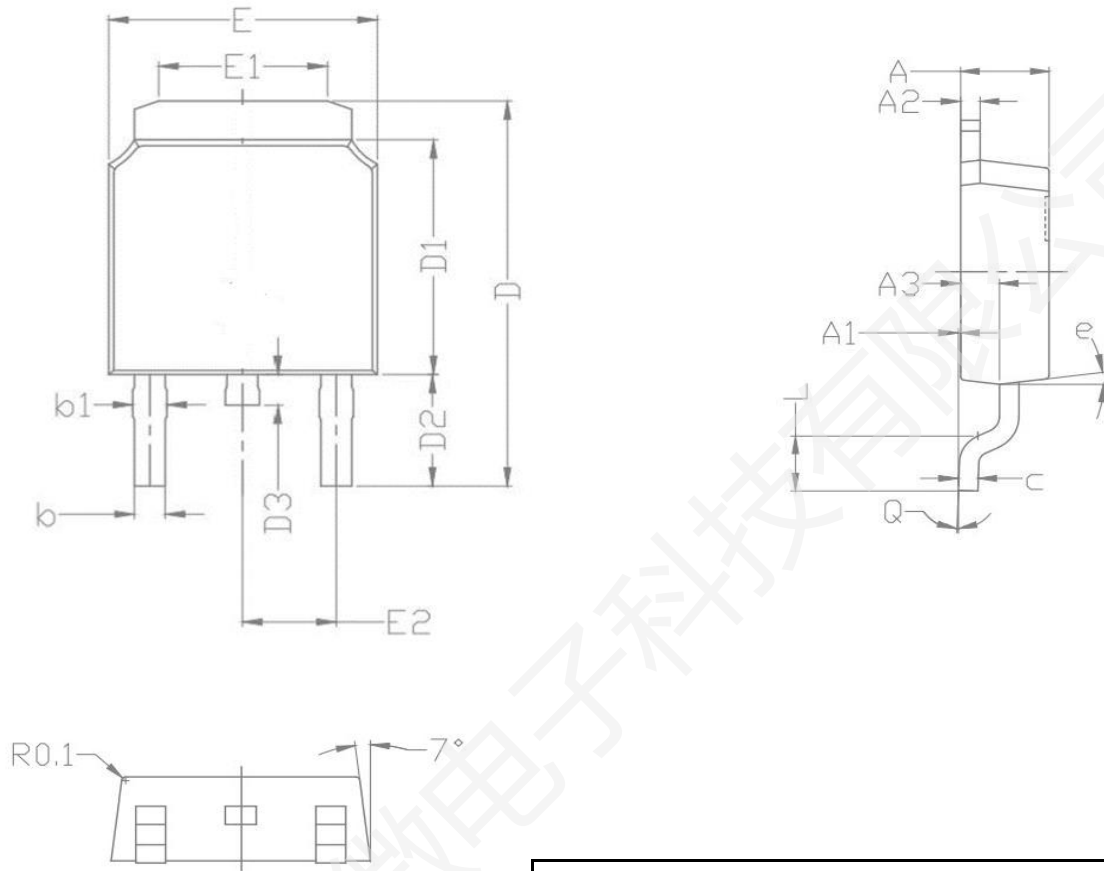


Figure 13: Max. Transient Thermal Impedance

 $Z_{thJC} = f(t_p)$; parameter: D

Test Circuit & Waveform:

Figure 14: Gate Charge Test Circuit & Waveform

Figure 15: Resistive Switching Test Circuit & Waveforms

Figure 16: Unclamped Inductive Switching Test Circuit & Waveforms

Package Outline:


COMMON			
PKG	TO-252		
Symbol	Min	Nom	Max
A	2.200	2.300	2.400
A1	0.000	0.075	0.150
A2	0.460	0.525	0.590
A3	0.960	1.010	1.060
b	0.640	0.720	0.800
C	0.450	0.515	0.580
D	9.800	10.025	10.350
D1	6.000	6.100	6.200
D2	2.850	2.900	3.100
D3	0.490	0.800	1.000
E	6.400	6.550	6.700
E1	4.050	4.130	4.600
E2	2.250	2.286	2.300
L	1.400	1.550	1.700
e	7°	8°	9°
Q	0°	5°	10°

Revision History:

Revison	Date	Descriptions
Rev 1.1	May.2024	Formal Version
Rev 1.0	Apr.2024	Initial Version

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